



## PATENT

Attv. Dkt. No. AMAT/3577.Y1/DSM/BCVD/JW

AF 11762  
ENT IFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
Judy Huang

Serial No.: 09/336,525

Confirmation No.: 7748

**Filed: June 18, 1999**

**For: Plasma Treatment to Enhance Adhesion and to Minimize Oxidation of Carbon-Containing Layers**

Group Art Unit: 1762

**Examiner: Marianne L. Padgett**

**MAIL STOP AF**  
**Commissioner for Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

**CERTIFICATE OF MAILING**  
**37 CFR 1.8**

I hereby certify that this correspondence is being deposited on 5/4, 2004 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

5/4/04 Keith E. Zuber  
Date Signature

Dear Sir:

**RESPONSE TO FINAL OFFICE ACTION DATED MARCH 4, 2004**

In response to the Final Office Action dated March 4, 2004, having a shortened statutory period for response set to expire on June 4, 2004, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/3577.Y1/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 4 of this paper.